## PME261, 10.2 - 25.4 mm Lead Spacing, 400 - 1,000 VDC



#### **Overview**

# Multilayer metallized paper, encapsulated and infused in self-extinguishing material, meeting the requirements of UL 94V-0.

### **Applications**

For general use in DC and low frequency pulse applications.

#### **Benefits**

Voltage range: 400 – 1,000 VDC; 220 – 500 VAC

• Capacitance range:  $0.001 - 1 \mu F$ 

• Lead spacing: 10.2 - 25.4 mm

• Capacitance tolerance: ±10%, ±20%, ±5% on request

Climatic category: 40/70/56, IEC 60068-1

• Tape & Reel packaging in accordance with IEC 60286-2

· RoHS compliant and lead-free terminations

 Operating temperature range of -40°C to +70°C in AC applications



### **Legacy Part Number System**

PME261	K	Α	5100	K	R30
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Capacitance Tolerance	Packaging
Metallized Paper	K = 220 E = 300 J = 500	A = 10.2 B = 15.2 C = 20.3 E = 25.4	The last three digits represent significant figures. First digit specifies the total number of digits in the capacitance value.	J = ±5% K = ±10% M = ±20%	See Ordering Options Table

### **New KEMET Part Number System**

Р	561	Н	E	103	K	220	Α
Capacitor Class	Series	Lead Spacing (mm)	Size Code	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VAC)	Packaging
P = Paper	Metallized Paper General Purpose	H = 10.2 Q = 15.2 C = 20.3 E = 25.4	See Dimension Table	First two digits indicate the two most significant digits of the capacitance value in picofarads. The third digit is the number of following zeroes.	J = ±5% K = ±10% M = ±20%	220 = 220 300 = 300 500 = 500	See Ordering Options Table



#### Benefits cont.

- Operating temperature range of -40°C to +100°C in DC applications
- Excellent self-healing properties. Ensures long life even when subjected to frequent over-voltages.
- · Good resistance to ionization due to impregnated dielectric
- · IEC Publication 166 Type 1
- · High dV/dt capability

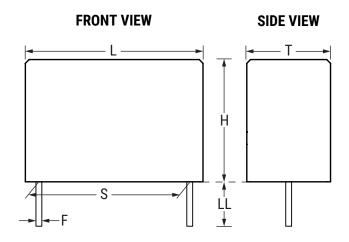
- Approved according to SE-MIL-QPL
- The capacitors meet the most stringent IEC humidity class, 56 days
- The impregnated paper ensures excellent stability giving outstanding reliability properties, especially in applications having continuous operation

### **Ordering Options Table**

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	KEMET Lead and Packaging Code	Legacy Lead and Packaging Code
	Standard lead and packaging options:			
	Bulk (bag) – short leads	6 +0/-1	С	R06
10.0	Bulk (bag) – maximum length leads	17 +0/-1	Α	R30
10.2	Tape & Reel (standard reel)	H <sub>0</sub> = 18.5 ±0.5	L	R19T0
	Other lead and packaging options:			
	Tape & Reel (large reel)	H <sub>0</sub> = 18.5 ±0.5	Р	R19T1
Native 10.2 formed to 7.5	Ammo pack	H <sub>0</sub> = 18.5 ±0.5	LAF3	R30XA
	Standard lead and packaging options:			
	Bulk (bag) – short leads	6 +0/-1	С	R06
15.2	Bulk (bag) – maximum length leads	30 +5/-0	Α	R30
15.2	Tape & Reel (standard reel)	H <sub>0</sub> = 18.5 ±0.5	L	R19T0
	Other lead and packaging options:			
	Tape & Reel (large reel)	H <sub>0</sub> = 18.5 ±0.5	Р	R19T1
	Ctandard land and narkaning autions			
	Standard lead and packaging options:	6 . 0 / 1	0	Doc
	Bulk (tray) – short leads Bulk (bag) – maximum length leads	6 +0/-1 30 +5/-0	C A	R06 R30
20.3	Tape & Reel (standard reel)	$H_0 = 18.5 \pm 0.5$	L	R19T0
	Other lead and packaging options:	110-10.3 ±0.3	L	1(1910
	Tape & Reel (large reel)	H <sub>0</sub> = 18.5 ±0.5	P	R19T1
07.4	Standard lead and packaging options:			
25.4	Bulk (tray) – short leads	6 +0/-1	С	R06
	Bulk (bag) – maximum length leads	30 +5/-0	Α	R30



### **Dimensions - Millimeters**



Cina Onda	S			Т		Н		L		F
Size Code	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
HE	10.2	±0.4	3.9	+0/-0.5	7.5	+0/-0.5	13.5	+0/-0.5	0.6	±0.05
HL	10.2	±0.4	5.1	+0/-0.5	10.5	+0/-0.5	13.5	+0/-0.5	0.6	±0.05
QE	15.2	±0.4	5.2	+0/-0.5	10.5	+0/-0.5	18.5	+0/-0.5	0.8	±0.05
QM	15.2	±0.4	7.3	+0/-0.5	13.0	+0/-0.5	18.5	+0/-0.5	0.8	±0.05
QP	15.2	±0.4	7.8	+0/-0.5	13.5	+0/-0.5	18.5	+0/-0.5	0.8	±0.05
CE	20.3	±0.4	7.6	+0/-0.5	14.0	+0/-0.5	24.0	+0/-0.5	0.8	±0.05
CG	20.3	±0.4	8.4	+0/-0.5	14.0	+0/-0.5	24.0	+0/-0.5	0.8	±0.05
CJ	20.3	±0.4	9.0	+0/-0.5	15.0	+0/-0.5	24.0	+0/-0.5	0.8	±0.05
CP	20.3	±0.4	11.3	+0/-0.5	16.5	+0/-0.5	24.0	+0/-0.5	0.8	±0.05
EH	25.4	±0.4	10.6	+0/-0.5	17.3	+0/-0.5	30.5	+0/-0.5	1.0	±0.05
EL	25.4	±0.4	15.3	+0/-0.5	22.0	+0/-0.5	30.5	+0/-0.5	1.0	±0.05
			Note: Se	Ordering Option	ons Table for l	ead length (LL)	options.			



### **Performance Characteristics**

Rated voltage V <sub>R</sub> (VDC)	400	630	1000			
Rated voltage V <sub>R</sub> (VAC)	220	300	500			
Capacitance range (µF)	0.0082 - 1.0	0.001 - 0.15	0.001 - 0.1			
Capacitance tolerance	±10%, ±20%, ±5% on re	equest				
Tamananahina	-40 to +70°C					
Temperature range	-40 to +100°C					
Climatic category	40/070/56					
Discinstian factor tank	N	Naximum Values at +23°	С			
Dissipation factor tanδ	1 k	Hz	1.3%			
	Measured a	at +20°C, According to IE	C 60384-2			
	Minim	um Values Between Terr	minals			
Insulation resistance	C ≤ 0.	33 μF	≥ 12,000 MΩ			
insulation resistance	C > 0.33 μF ≥ 4,000 MΩ • μF					
	PME261 K measured at 100 VDC after 60 seconds, +23°C					
	PME261 E and J measured at 500 VDC after 60 seconds, +23°C					

### **Environmental Test Data**

Test	IEC Publication	Procedure
Vibration	IEC 60068-2-6 Test Fc	3 directions at 2 hours each 10 - 55 Hz at 0.75 mm or 98 m/s <sup>2</sup>
Bump	IEC 60068-2-29 Test Eb	4,000 bumps at 390 m/s <sup>2</sup>
Solderability	IEC 60068-2-20 Test Ta	Solder globule method Wetting time for d ≤ 0.8 < 1 second for d > 0.8 < 1.5 seconds
Passive Flammability	IEC 60695-2-2	
Damp Heat Steady State	IEC 60068-2-3 Test Ca	+40°C and 90 - 95% RH, 56 days

### **Environmental Compliance**

All KEMET Metallized Impregnated Paper capacitors are RoHS compliant.





### **Table 1 - Ratings & Part Number Reference**

Capacitance		Maximun ensions in	-	Lead	dV/dt	Kemet	Legacy
Value (µF)	T	Н	L	Spacing (S)	(V/µs)	Part Number	Part Number
0.0082	3.9	7.5	13.5	10.2	2,000	P561HE822(1)220(2)	PME261KA4820(1)(2)
0.010	3.9	7.5	13.5	10.2	2,000	P561HE103(1)220(2)	PME261KA5100(1)(2)
0.015	5.1	10.5	13.5	10.2	2,000	P561HL153(1)220(2)	PME261KA5150(1)(2)
0.022	5.1	10.5	13.5	10.2	2,000	P561HL223(1)220(2)	PME261KA5220(1)(2)
0.033	5.2	10.5	18.5	15.2	1,600	P561QE333(1)220(2)	PME261KB5330(1)(2)
0.047	5.2	10.5	18.5	15.2	1,300	P561QE473(1)220(2)	PME261KB5470(1)(2)
0.068	7.3	13.0	18.5	15.2	1,100	P561QM683(1)220(2)	PME261KB5680(1)(2)
0.1	7.3	13.0	18.5	15.2	850	P561QM104(1)220(2)	PME261KB6100(1)(2)
0.15	7.6	14.0	24.0	20.3	700	P561CE154(1)220(2)	PME261KC6150(1)(2)
0.68	15.3	22.0	30.5	25.4	300	P561EL684(1)220(2)	PME261KE6680(1)(2)
0.001	3.9	7.5	13.5	10.2	2,000	P561HE102(1)300(2)	PME261EA4100(1)(2)
0.0015	3.9	7.5	13.5	10.2	2,000	P561HE152(1)300(2)	PME261EA4150(1)(2)
0.0022	3.9	7.5	13.5	10.2	2,000	P561HE222(1)300(2)	PME261EA4220(1)(2)
0.0033	3.9	7.5	13.5	10.2	2,000	P561HE332(1)300(2)	PME261EA4330(1)(2)
0.0047	3.9	7.5	13.5	10.2	2,000	P561HE472(1)300(2)	PME261EA4470(1)(2)
0.0068	3.9	7.5	13.5	10.2	2,000	P561HE682(1)300(2)	PME261EA4680(1)(2)
0.01	5.1	10.5	13.5	10.2	2,000	P561HL103(1)300(2)	PME261EA5100(1)(2)
0.015	5.1	10.5	13.5	10.2	2,000	P561HL153(1)300(2)	PME261EA5150(1)(2)
0.022	5.2	10.5	18.5	15.2	2,000	P561QE223(1)300(2)	PME261EB5220(1)(2)
0.033	5.2	10.5	18.5	15.2	2,000	P561QE333(1)300(2)	PME261EB5330(1)(2)
0.047	7.3	13.0	18.5	15.2	1,600	P561QM473(1)300(2)	PME261EB5470(1)(2)
0.068	7.3	13.0	18.5	15.2	1,200	P561QM683(1)300(2)	PME261EB5680(1)(2)
0.1	7.6	14.0	24.0	20.3	900	P561CE104(1)300(2)	PME261EC6100(1)(2)
0.15	9.0	15.0	24.0	20.3	650	P561CJ154(1)300(2)	PME261EC6150(1)(2)
0.001	3.9	7.5	13.5	10.2	2,000	P561HE102(1)500(2)	PME261JA4100(1)(2)
0.0015	3.9	7.5	13.5	10.2	2,000	P561HE152(1)500(2)	PME261JA4150(1)(2)
0.0022	3.9	7.5	13.5	10.2	2,000	P561HE222(1)500(2)	PME261JA4220(1)(2)
0.0033	3.9	7.5	13.5	10.2	2,000	P561HE332(1)500(2)	PME261JA4330(1)(2)
0.0047	5.1	10.5	13.5	10.2	2,000	P561HL472(1)500(2)	PME261JA4470(1)(2)
0.0068	5.1	10.5	13.5	10.2	2,000	P561HL682(1)500(2)	PME261JA4680(1)(2)
0.01	5.2	10.5	18.5	15.2	2,000	P561QE103(1)500(2)	PME261JB5100(1)(2)
0.015	5.2	10.5	18.5	15.2	2,000	P561QE153(1)500(2)	PME261JB5150(1)(2)
0.022	7.3	13.0	18.5	15.2	2,000	P561QM223(1)500(2)	PME261JB5220(1)(2)
0.033	7.8	13.5	18.5	15.2	2,000	P561QP333(1)500(2)	PME261JB5330(1)(2)
0.047	7.6	14.0	24.0	20.3	2,000	P561CE473(1)500(2)	PME261JC5470(1)(2)
0.068	9.0	15.0	24.0	20.3	1,400	P561CJ683(1)500(2)	PME261JC5680(1)(2)
0.1	11.3	16.5	24.0	20.3	950	P561CP104(1)500(2)	PME261JC6100(1)(2)
Capacitance Value (µF)	T (mm)	H (mm)	L (mm)	Lead Spacing (S)	dV/dt (V/μs)	KEMET Part Number	Legacy Part Number

<sup>(1)</sup>  $K = \pm 10\%$ ,  $M = \pm 20\%$ ,  $J = \pm 5\%$  on request.

<sup>(2)</sup> Insert lead and packaging code. See Ordering Options Table for available options.



### **Soldering Process**

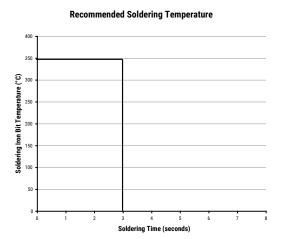
The implementation of the RoHS directive has resulted in the selection of SnAuCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of  $183^{\circ}$ C for SnPb eutectic alloy to  $217 - 221^{\circ}$ C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is  $160 - 170^{\circ}$ C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 - 15 mm), and great care has to be taken during soldering. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. Please see Figure 1. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result to degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

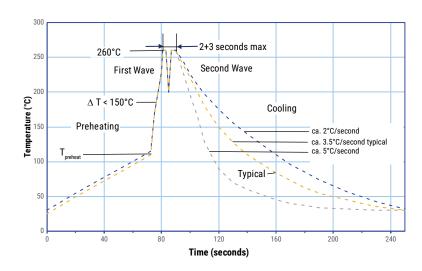
#### **Manual Soldering Recommendations**

Following is the recommendation for manual soldering with a soldering iron.



Soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than three seconds.

#### **Wave Soldering Recommendations**





### **Soldering Process cont.**

#### **Wave Soldering Recommendations cont.**

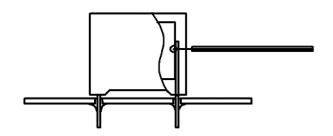
1. The table indicates the maximum set-up temperature of the soldering process Figure 1

Dielectric		imum Pre emperatu	Maximum Peak Soldering Temperature		
Film Material	Capacitor pitch ≤ 10 mm	Capacitor pitch = 15 mm	Capacitor pitch > 15 mm	Capacitor pitch ≤ 15 mm	Capacitor pitch > 15 mm
Polyester	130°C	130°C	130°C	270°C	270°C
Polypropylene	110°C	110°C	130°C	260°C	270°C
Paper	130°C 130°C 140°C		140°C	270°C	270°C
Polyphenylene Sulphide	150°C	150°C	270°C	270°C	

2. The maximum temperature measured inside the capacitor:

Set the temperature so that inside the element the maximum temperature is below the limit:

Dielectric Film Material	Maximum temperature measured inside the element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene Sulphide	160°C



Temperature monitored inside the capacitor.

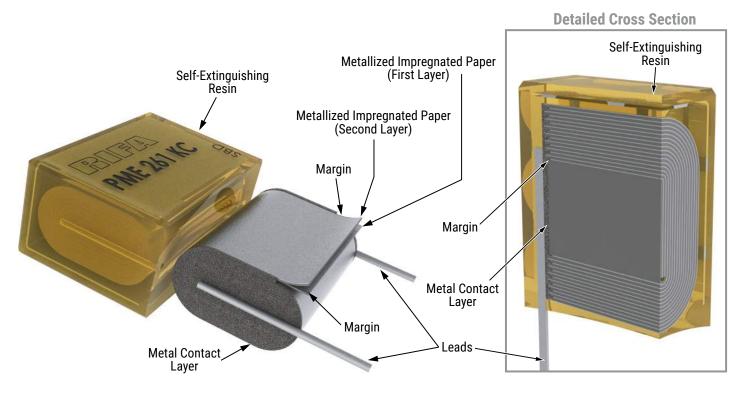
#### **Selective Soldering Recommendations**

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped, and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components and pressed against the lower surface of the board to solder the components.

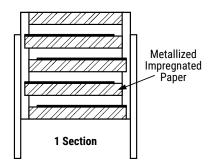
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document; however, instead of two baths, there is only one bath with a time of 3 to 10 seconds. In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.



#### Construction

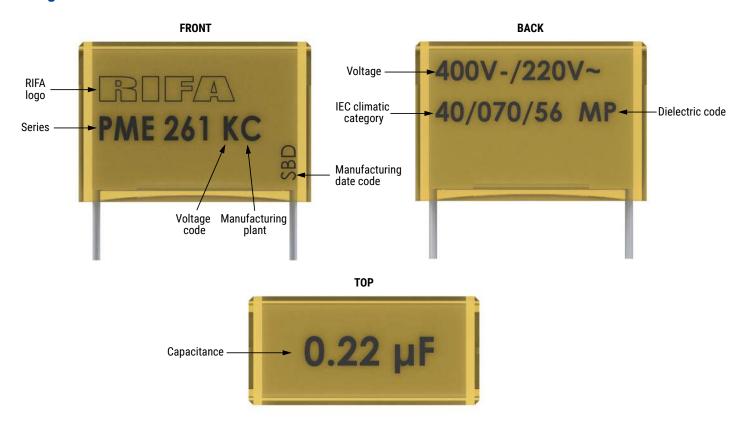


### **Winding Scheme**





### Marking





### **Packaging Quantities**

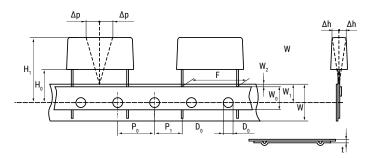
Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel 360 mm	Large Reel 500 mm	Ammo Formed
	3.9	7.5	13.5	2,000	1,000	700	1,400	800
10.2	4.1	8.2	13.5	2,000	1,000	600		780
	5.1	10.5	13.5	1,600	800	600	1,200	630
		40.5	10.0	1.000	500	600	1	
	5.5	12.5	18.0	1,000	500	600		
	6.5	12.5	18.0	600	400	400		
	7.5	14.5	18.0	600	400	400		
	8.5	16.0	18.0	400	250	400		
15.2	5.2	10.5	18.5	1,000	500	600		
15.2	5.5	11.0	18.5	1,000	500	500		
	6.0	12.5	18.5	600	400	400		
	7.3	13.0	18.5	600	400	400	800	
	7.8	13.5	18.5	600	400	400		
	8.5	14.3	18.5	500	300	350		
		110	212	1				
	7.6	14.0	24.0	1,500	250	250	500	
20.3	8.4	14.0	24.0	1,200	200	250	500	
20.0	9.0	15.0	24.0	1,500	200	250		
	11.3	16.5	24.0	1,000	150	180	400	
	10.6	16.1	30.5	1,000	150			
	10.5	17.3	30.5	1,000	100			
25.4	12.1	19.0	30.5	800	100			
	15.3	22.0	30.5	600	75			



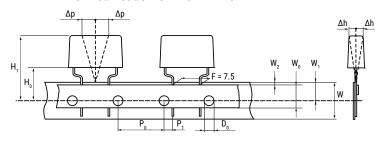
### Lead Taping & Packaging (IEC 60286-2)

#### Lead Spacing 10.2 - 15.2 mm

#### Lead Spacing 20.3 - 22.5 mm



Formed Leads from 10.2 - 7.5 mm



### **Taping Specification**

	Dimensions in mm											
Lead Spacing	+0.6/-0.1	F	Formed 7.5	10.2	15.2	20.3	22.5	F				
Carrier Tape Width	±0.5	W	18.0	18.0	18.0	18.0	18.0	18 +1/-0.5				
Hold-Down Tape Width	Minimum	$W_{0}$	5.0	5.0	5.0	5.0	5.0					
Position of Sprocket Hole	±0.5	W <sub>1</sub>	9.0	9.0	9.0	9.0	9.0	9 +0.75/-0.5				
Distance Between Tapes	Maximum	W <sub>2</sub>	3.0	3.0	3.0	3.0	3.0	3.0				
Sprocket Hole Diameter	±0.2	D <sub>0</sub>	4.0	4.0	4.0	4.0	4.0	4.0				
Feed Hole Lead Spacing	±0.3	P <sub>0</sub> <sup>(1)</sup>	12.7(4)	12.7	12.7	12.7	12.7	12.7				
Distance Lead - Feed Hole	±0.7	P <sub>1</sub>	3.75	7.6	5.1	8.9	5.3	P <sup>1</sup>				
Deviation Tape - Plane	Maximum	Δр	1.3	1.3	1.3	1.3	1.3	1.3				
Lateral Deviation	Maximum	Δh	2.0	2.0	2.0	2.0	2.0	2.0				
Total Thickness	±0.2	t	0.7	0.7	0.7	0.7	0.9 Maximum	0.9 Maximum				
Sprocket Hole/Cap Body	Nominal	H <sub>0</sub> <sup>(2)</sup>	18 +2/-0	18 +2/-0	18 +2/-0	18 +2/-0	18.5 ±0.5	18 +2/-0				
Sprocket Hole/Top of Cap Body	Maximum	H <sub>1</sub> <sup>(3)</sup>	43	43	43	58	58	58 Maximum				

<sup>(1)</sup> Maximum cumulative feed hole error, 1 mm per 20 parts

<sup>(2) 16.5</sup> mm available on request

<sup>(3)</sup> Depending on case size

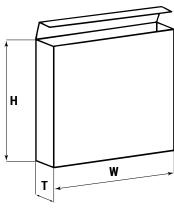
<sup>(4) 15</sup> mm available on request



### Lead Taping & Packaging (IEC 60286-2) cont.

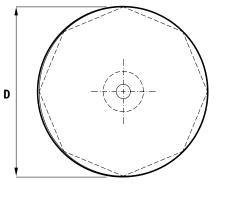
### **Ammo Specifications**

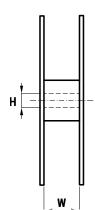
Series	Dimensions (mm)				
Series	Н	W	T		
R4x, R4x+R, R7x, RSB					
F5A, F5B, F5D	360	340	59		
F6xx, F8xx					
PHExxx, PMExxx, PMRxxx	330	330	50		



### **Reel Specifications**

Series	Dimensions (mm)		
	D	Н	W
R4x, R4x+R, R7x, RSB			
F5A, F5B, F5D	355 500	30 25	55 (Max)
F6xx, F8xx	300	23	
PHExxx, PMExxx, PMRxxx	360 500	30	46 (Max)





### **Manufacturing Date Code (IEC-60062)**

Y = Year, Z = Month				
Year	Code	Month	Code	
2010	Α	January	1	
2011	В	February	2	
2012	С	March	3	
2013	D	April	4	
2014	Е	May	5	
2015	F	June	6	
2016	Н	July	7	
2017	J	August	8	
2018	K	September	9	
2019	L	October	0	
2020	M	November	N	
2021	N	December	D	
2022	Р			
2023	R			
2024	S			
2025	Т			
2026	U			
2027	V			
2028	W			
2029	X			
2030	Α			



### **KEMET Electronics Corporation Sales Offices**

For a complete list of our global sales offices, please visit www.kemet.com/sales.

#### **Disclaimer**

YAGEO Corporation and its affiliates do not recommend the use of commercial, automotive, and/or COTS grade products for high reliability applications or manned space flight.

All product specifications, statements, information and data (collectively, the "Information") in this datasheet are subject to change. The customer is responsible for checking and verifying the extent to which the Information contained in this publication is applicable to an order at the time the order is placed. All Information given herein is believed to be accurate and reliable, but it is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on KEMET Electronics Corporation's ("KEMET") knowledge of typical operating conditions for such applications, but are not intended to constitute – and KEMET specifically disclaims – any warranty concerning suitability for a specific customer application or use. The Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by KEMET with reference to the use of KEMET's products is given gratis, and KEMET assumes no obligation or liability for the advice given or results obtained.

Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicated or that other measures may not be required.